The Intersil ISL8323-ISL8325 devices are precision, dual analog switches designed to operate from a single +2.7 V to +12 V supply. Targeted applications include battery powered equipment that benefit from the devices' low power consumption $(5 \mu \mathrm{~W})$, low leakage currents (100pA max), and fast switching speeds. Excellent $\mathrm{R}_{\mathrm{ON}}$ matching and flatness maintain signal fidelity over the whole input range.

The ISL8323/ISL8324/ISL8325 are dual single-pole/singlethrow (SPST) devices. The ISL8323 has two normally open (NO) switches; the ISL8324 has two normally closed (NC) switches; the ISL8325 has one NO and one NC switch and can be used as an SPDT. Table 1 summarizes the performance of this family. For higher performance, pin compatible versions, or SOT-23 packaged devices, see the ISL5120-23 data sheet.

TABLE 1. SUMMARY OF FEATURES

|  | ISL8323 | ISL8324 <br> No Longer <br> Available or <br> Supported | ISL8325 <br> No Longer <br> Available or <br> Supported |
| :--- | :---: | :---: | :---: |
| Number of Switches | 2 | 2 | 2 |
| SW 1 / SW 2 | NO / NO | NC / NC | NO / NC |
| 3.3V RON (Max) | $175 \Omega$ | $175 \Omega$ | $175 \Omega$ |
| 3.3V toN / tofF (Max) | $400 / 125 \mathrm{~ns}$ | $400 / 125 \mathrm{~ns}$ | $400 / 125 \mathrm{~ns}$ |
| 5V RON (Max) | $60 \Omega$ | $60 \Omega$ | $60 \Omega$ |
| 5V toN / toff (Max) | $150 / 100 \mathrm{~ns}$ | $150 / 100 \mathrm{~ns}$ | $150 / 100 \mathrm{~ns}$ |
| Packages | 8 Ld SOIC |  |  |

## Related Literature

- Technical Brief TB363 Guidelines for Handling and Processing Moisture Sensitive Surface Mount Devices (SMDs)


## Features

- Drop-in Replacements for MAX323 - MAX325 in Single Supply Applications up to 12V.
- ON Resistance (RON) . . . . . . . . . . . . . . . . . . $60 \Omega$ (Max)
- RON Matching Between Channels. . . . . . . . . . . . . $2 \Omega$ (Max)
- Low Charge Injection . . . . . . . . . . . . . . . . . . . . . . . 5pC (Max)
- Single Supply Operation. . . . . . . . . . . . . . . . . +2.7V to +12V
- Low Power Consumption ( $\mathrm{P}_{\mathrm{D}}$ ) . . . . . . . . . . . . . . . . . . . . $<5 \mu \mathrm{~W}$
- Low Leakage Current (Max at $85^{\circ} \mathrm{C}$ ) . . . . . . . . . . . . . 5nA
- Fast Switching Action
- ton . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 150ns (Max)
- IOFF . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 100ns (Max)
- Guaranteed Break-Before-Make (ISL8325 only)
- Minimum 2000V ESD Protection per Method 3015.7
- TTL, CMOS Compatible
- Pb-free available


## Applications

- Battery Powered, Handheld, and Portable Equipment
- Cellular/Mobile Phones
- Pagers
- Laptops, Notebooks, Palmtops
- Communications Systems
- Military Radios
- PBX, PABX
- Test Equipment
- Ultrasound
- Electrocardiograph
- Heads-Up Displays
- Audio and Video Switching
- Various Circuits
- +3V/+5V DACs and ADCs
- Sample and Hold Circuits
- Digital Filters
- Operational Amplifier Gain Switching Networks
- High Frequency Analog Switching
- High Speed Multiplexing
- Integrator Reset Circuits


## Pinouts (Note 1)

ISL8323 (SOIC)
TOP VIEW


ISL8324 (SOIC)
TOP VIEW


ISL8325 (SOIC)
TOP VIEW


NOTE:

1. Switches Shown for Logic "0" Input.

## Truth Table

| LOGIC | ISL8323 | ISL8324 | ISL8325 |  |
| :---: | :---: | :---: | :---: | :---: |
|  | SW 1,2 | SW 1,2 | SW 1 | SW 2 |
| 0 | OFF | ON | OFF | ON |
| 1 | ON | OFF | ON | OFF |

NOTE: Logic " 0 " $\leq 0.8 \mathrm{~V}$. Logic " 1 " $\geq 2.4 \mathrm{~V}$.
Pin Descriptions

| PIN | FUNCTION |
| :---: | :---: |
| V+ | System Power Supply Input (+2.7V to +12V) |
| GND | Ground Connection |
| IN | Digital Control Input |
| COM | Analog Switch Common Pin |
| NO | Analog Switch Normally Open Pin |
| NC | Analog Switch Normally Closed Pin |

## Ordering Information

| PART NO. (BRAND) (Notes 2, 3) | TEMP. <br> RANGE ( ${ }^{\circ} \mathrm{C}$ ) | PACKAGE <br> RoHS Compliant | PKG. DWG. \# |
| :---: | :---: | :---: | :---: |
| ISL8323IBZ | -40 to 85 | 8 Ld SOIC | M8.15 |
| ISL8324IBZ (No longer available, recommended replacement: ISL8323IBZ) | -40 to 85 | 8 Ld SOIC | M8.15 |
| ISL8325IBZ (No longer available, recommended replacement: ISL8323IBZ) | -40 to 85 | 8 Ld SOIC | M8.15 |

NOTES:
2. Add "-T" suffix to part number for tape and reel packaging.
3. Intersil Pb -free products employ special Pb -free material sets; molding compounds/die attach materials and $100 \%$ matte tin plate termination finish, which is compatible with both SnPb and Pb -free soldering operations. Intersil Pb -free products are MSL classified at Pb -free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J Std-020B.

## Absolute Maximum Ratings

| V+ to GND | -0.3 to15V |
| :---: | :---: |
| Input Voltages |  |
| IN, NO, NC, COM (Note 2) | -0.3 to ((V+) + 0.3V) |
| Continuous Current (NO, NC, or COM) | 30 mA |
| Peak Current NO, NC, or COM (Pulsed 1ms, 10\% Duty Cycle, Max) | . 100 mA |
| ESD Rating (Per MIL-STD-883 Method | . $>2 \mathrm{kV}$ |

## Thermal Information

| Thermal Resistance (Typical, Note 5) | $\theta_{\mathrm{JA}}\left({ }^{\circ} \mathrm{C} / \mathrm{W}\right)$ |
| :---: | :---: |
| 8 LD SOIC Package. | 170 |
| Maximum Junction Temperature (Plastic Package) | $150^{\circ} \mathrm{C}$ |
| Moisture Sensitivity (See Technical Brief TB363) |  |
| All Packages | Level 1 |
| Maximum Storage Temperature Range. | $5^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$ |
| Maximum Lead Temperature (Soldering 10s). (SOIC - Lead Tips Only) | . . $300^{\circ} \mathrm{C}$ |

## Operating Conditions

Temperature Range
ISL832XIX $\qquad$ $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.
NOTES:
4. Signals on NC, NO, COM, or IN exceeding V+ or GND are clamped by internal diodes. Limit forward diode current to maximum current ratings.
5. $\theta_{\mathrm{JA}}$ is measured with the component mounted on a low effective thermal conductivity test board in free air. See Tech Brief TB379 for details.

## Electrical Specifications - 5V Supply Test Conditions: $\mathrm{V}+=+4.5 \mathrm{~V}$ to $+5.5 \mathrm{~V}, \mathrm{GND}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{INH}}=2.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{INL}}=0.8 \mathrm{~V}(\mathrm{Note} 6)$, Unless Otherwise Specified

| PARAMETER | TEST CONDITIONS | TEMP $\left({ }^{\circ} \mathrm{C}\right)$ | MIN (NOTE 7) | TYP | MAX (NOTE 7) | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ANALOG SWITCH CHARACTERISTICS |  |  |  |  |  |  |
| Analog Signal Range, V ${ }_{\text {ANALOG }}$ |  | Full | 0 | - | V+ | V |
| ON Resistance, RON | $\mathrm{V}+=4.5 \mathrm{~V}, \mathrm{I}_{\mathrm{COM}}=1.0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=3.5 \mathrm{~V} \text {, }$ See Figure 5 | 25 | - | - | 60 | $\Omega$ |
|  |  | Full | - | - | 75 | $\Omega$ |
| RON Matching Between Channels, $\Delta \mathrm{R}_{\mathrm{ON}}$ | $\mathrm{V}+=5 \mathrm{~V}, \mathrm{I}_{\mathrm{COM}}=1.0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{NO}}$ or $\mathrm{V}_{\mathrm{NC}}=3 \mathrm{~V}$ | 25 | - | 0.8 | 2 | $\Omega$ |
|  |  | Full | - | - | 4 | $\Omega$ |
| $\mathrm{R}_{\text {ON }}$ Flatness, R $\mathrm{FLAT}^{\text {(ON }}$ ) | $\mathrm{V}+=5 \mathrm{~V}, \mathrm{I}_{\mathrm{COM}}=1.0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{NO}}$ or $\mathrm{V}_{\mathrm{NC}}=1 \mathrm{~V}, 2 \mathrm{~V}, 3 \mathrm{~V}$ | Full | - | 7 | 8 | $\Omega$ |
| NO or NC OFF Leakage Current, $\mathrm{I}_{\mathrm{NO}(\mathrm{OFF})}$ or $\mathrm{I}_{\mathrm{NC}}$ (OFF) | $\mathrm{V}+=5.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{COM}}=1 \mathrm{~V}, 4.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=4.5 \mathrm{~V}, 1 \mathrm{~V} \text {, }$ Note 8 | 25 | -0.1 | - | 0.1 | nA |
|  |  | Full | -5 | - | 5 | nA |
| COM OFF Leakage Current, ICOM(OFF) | $\mathrm{V}+=5.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{COM}}=4.5 \mathrm{~V}, 1 \mathrm{~V}, \mathrm{~V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=1 \mathrm{~V}, 4.5 \mathrm{~V}$ Note 8 | 25 | -0.1 | - | 0.1 | nA |
|  |  | Full | -5 | - | 5 | nA |
| COM ON Leakage Current, ICOM(ON) | $\mathrm{V}+=5.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{COM}}=5 \mathrm{~V}$, or $\mathrm{V}_{\mathrm{NO}}$ or $\mathrm{V}_{\mathrm{NC}}=5 \mathrm{~V}$, Note 8 | 25 | -0.2 | - | 0.2 | nA |
|  |  | Full | -10 | - | 10 | nA |
| DYNAMIC CHARACTERISTICS |  |  |  |  |  |  |
| Turn-ON Time, ton | $\mathrm{V}_{\mathrm{NO}}$ or $\mathrm{V}_{\mathrm{NC}}=3 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}, \mathrm{V}_{\mathrm{IN}}=0$ to 3 V , See Figure 1 | 25 | - | - | 150 | ns |
|  |  | Full | - | - | 240 | ns |
| Turn-OFF Time, toff | $\mathrm{V}_{\mathrm{NO}}$ or $\mathrm{V}_{\mathrm{NC}}=3 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}, \mathrm{V}_{\mathrm{IN}}=0$ to 3 V , See Figure 1 | 25 | - | - | 100 | ns |
|  |  | Full | - | - | 150 | ns |
| Break-Before-Make Time Delay (ISL8325), $\mathrm{t}_{\mathrm{D}}$ | $\mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}, \mathrm{~V}_{\mathrm{NO}}=\mathrm{V}_{\mathrm{NC}}=3 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN}}=0 \text { to } 3 \mathrm{~V} \text {, }$ See Figure 3 | Full | 2 | 10 | - | ns |
| Charge Injection, Q | $\mathrm{C}_{\mathrm{L}}=1.0 \mathrm{nF}, \mathrm{V}_{\mathrm{G}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{G}}=0 \Omega$, See Figure 2 | 25 | - | - | 5 | pC |
| OFF Isolation | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{f}=1 \mathrm{MHz}$, See Figure 4 | 25 | - | 72 | - | dB |
| Crosstalk (Channel-to-Channel) | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{f}=1 \mathrm{MHz}$, See Figure 6 | 25 | - | -85 | - | dB |
| NO or NC OFF Capacitance, C OFF | $\mathrm{f}=1 \mathrm{MHz}, \mathrm{V}_{\mathrm{NO}}$ or $\mathrm{V}_{\mathrm{NC}}=\mathrm{V}_{\mathrm{COM}}=0 \mathrm{~V}$, See Figure 7 | 25 | - | 9 | - | pF |
| COM OFF Capacitance, C COM(OFF) | $\mathrm{f}=1 \mathrm{MHz}, \mathrm{V}_{\mathrm{NO}}$ or $\mathrm{V}_{\mathrm{NC}}=\mathrm{V}_{\mathrm{COM}}=0 \mathrm{~V}$, See Figure 7 | 25 | - | 9 | - | pF |
| COM ON Capacitance, $\mathrm{C}_{\text {COM }}(\mathrm{ON})$ | $\mathrm{f}=1 \mathrm{MHz}, \mathrm{V}_{\mathrm{NO}}$ or $\mathrm{V}_{\mathrm{NC}}=\mathrm{V}_{\mathrm{COM}}=0 \mathrm{~V}$, See Figure 7 | 25 | - | 22 | - | pF |
| POWER SUPPLY CHARACTERISTICS |  |  |  |  |  |  |
| Power Supply Range |  | Full | 2.7 |  | 12 | V |
| Positive Supply Current, I+ | $\mathrm{V}+=5.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V}$ or $\mathrm{V}+$, all channels on or off | Full | -1 | 0.0001 | 1 | $\mu \mathrm{A}$ |

## Electrical Specifications - 5V Supply Test Conditions: $\mathrm{V}+=+4.5 \mathrm{~V}$ to $+5.5 \mathrm{~V}, \mathrm{GND}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{INH}}=2.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{INL}}=0.8 \mathrm{~V}$ (Note 6 ), Unless Otherwise Specified (Continued)

| PARAMETER | TEST CONDITIONS | $\begin{aligned} & \text { TEMP } \\ & \left({ }^{\circ} \mathrm{C}\right) \end{aligned}$ | $\begin{gathered} \text { MIN } \\ \text { (NOTE 7) } \end{gathered}$ | TYP | $\begin{gathered} \text { MAX } \\ \text { (NOTE 7) } \\ \hline \end{gathered}$ | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DIGITAL INPUT CHARACTERISTICS |  |  |  |  |  |  |
| Input Voltage Low, $\mathrm{V}_{\text {INL }}$ |  | Full | - | - | 0.8 | V |
| Input Voltage High, $\mathrm{V}_{\text {INH }}$ |  | Full | 2.4 | - | - | V |

NOTES:
6. $\mathrm{V}_{\mathrm{IN}}=$ input voltage to perform proper function.
7. The algebraic convention, whereby the most negative value is a minimum and the most positive a maximum, is used in this data sheet.
8. Leakage parameter is $100 \%$ tested at high temp, and guaranteed by correlation at $25^{\circ} \mathrm{C}$.

Electrical Specifications-3.3V Supply Test Conditions: $\mathrm{V}+=+3.0 \mathrm{~V}$ to $+3.6 \mathrm{~V}, \mathrm{GND}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{INH}}=2.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{INL}}=0.8 \mathrm{~V}$ (Note 6), Unless Otherwise Specified

| PARAMETER | TEST CONDITIONS | $\begin{gathered} \text { TEMP } \\ \left({ }^{\circ} \mathrm{C}\right) \end{gathered}$ | $\begin{gathered} \hline \text { MIN } \\ \text { (NOTE 7) } \end{gathered}$ | TYP | $\begin{array}{c\|} \hline \text { MAX } \\ \text { (NOTE 7) } \end{array}$ | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ANALOG SWITCH CHARACTERISTICS |  |  |  |  |  |  |
| Analog Signal Range, $\mathrm{V}_{\text {ANALOG }}$ |  | Full | 0 | - | V+ | V |
| ON Resistance, R ON | $\mathrm{V}+=3 \mathrm{~V}, \mathrm{I}_{\mathrm{COM}}=1.0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{NO}}$ or $\mathrm{V}_{\mathrm{NC}}=1.5 \mathrm{~V}$ | 25 | - | - | 175 | $\Omega$ |
|  |  | Full | - | - | 275 | $\Omega$ |
| DYNAMIC CHARACTERISTICS |  |  |  |  |  |  |
| Turn-ON Time, ton | $\mathrm{V}_{\mathrm{NO}}$ or $\mathrm{V}_{\mathrm{NC}}=1.5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}, \mathrm{V}_{\mathrm{IN}}=0$ to 3 V | 25 | - | - | 400 | ns |
|  |  | Full |  |  | 500 | ns |
| Turn-OFF Time, ${ }^{\text {toFF }}$ | $\mathrm{V}_{\mathrm{NO}}$ or $\mathrm{V}_{\mathrm{NC}}=1.5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}, \mathrm{V}_{\mathrm{IN}}=0$ to 3 V | 25 | - | - | 125 | ns |
|  |  | Full | - | - | 175 | ns |
| Break-Before-Make Time Delay (ISL8325), $\mathrm{t}_{\mathrm{D}}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}, \mathrm{~V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=1.5 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{IN}}=0 \text { to } 3 \mathrm{~V} \end{aligned}$ | Full | 2 | - | - | ns |
| Charge Injection, Q | $\mathrm{C}_{\mathrm{L}}=1.0 \mathrm{nF}, \mathrm{V}_{\mathrm{G}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{G}}=0 \Omega$ | 25 | - | - | 5 | pC |
| POWER SUPPLY CHARACTERISTICS |  |  |  |  |  |  |
| Positive Supply Current, I+ | $\mathrm{V}+=3.6 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=0 \mathrm{~V}$ or $\mathrm{V}+$, all channels on or off | Full | -1 | - | 1 | $\mu \mathrm{A}$ |

## Test Circuits and Waveforms



Logic input waveform is inverted for switches that have the opposite logic sense.


Repeat test for all switches. $\mathrm{C}_{\mathrm{L}}$ includes fixture and stray capacitance.

$$
\mathrm{V}_{\mathrm{OUT}}=\mathrm{V}_{(\mathrm{NO} \text { or } \mathrm{NC})} \frac{\mathrm{R}_{\mathrm{L}}}{\mathrm{R}_{\mathrm{L}}+\mathrm{R}_{(\mathrm{ON})}}
$$

FIGURE 1B. TEST CIRCUIT

FIGURE 1. SWITCHING TIMES


FIGURE 2A. MEASUREMENT POINTS
FIGURE 2. CHARGE INJECTION


FIGURE 3A. MEASUREMENT POINTS (ISL8325 ONLY)

$C_{L}$ includes fixture and stray capacitance.
FIGURE 3B. TEST CIRCUIT (ISL8325 ONLY)

FIGURE 3. BREAK-BEFORE-MAKE TIME

Test Circuits and Waveforms (Continued)


FIGURE 4. OFF ISOLATION TEST CIRCUIT


FIGURE 6. CROSSTALK TEST CIRCUIT


FIGURE 5. RON TEST CIRCUIT


FIGURE 7. CAPACITANCE TEST CIRCUIT

## Detailed Description

The ISL8323-ISL8325 dual analog switches offer precise switching capability from a single 2.7 V to 12 V supply with low on-resistance and high speed operation. The devices are especially well suited to portable battery powered equipment thanks to the low operating supply voltage ( 2.7 V ), low power consumption $(5 \mu \mathrm{~W})$, low leakage currents (100pA max), and the small SOIC packaging. High frequency applications also benefit from the wide bandwidth, and the very high off isolation and crosstalk rejection.

## Supply Sequencing And Overvoltage Protection

With any CMOS device, proper power supply sequencing is required to protect the device from excessive input currents which might permanently damage the IC. All I/O pins contain ESD protection diodes from the pin to $\mathrm{V}+$ and to GND (see Figure 8). To prevent forward biasing these diodes, V+ must be applied before any input signals, and input signal voltages must remain between V+ and GND. If these conditions cannot be guaranteed, then one of the following two protection methods should be employed.

Logic inputs can easily be protected by adding a $1 \mathrm{k} \Omega$ resistor in series with the input (see Figure 8). The resistor limits the input current below the threshold that produces permanent damage, and the sub-microamp input current produces an insignificant voltage drop during normal operation.
Adding a series resistor to the switch input defeats the purpose of using a low $\mathrm{R}_{\mathrm{ON}}$ switch, so two small signal diodes can be added in series with the supply pins to provide overvoltage protection for all pins (see Figure 8). These additional diodes limit the analog signal from 1V below V+ to 1 V above GND. The low leakage current performance is unaffected by this approach, but the switch resistance may increase, especially at low supply voltages.


FIGURE 8. OVERVOLTAGE PROTECTION

## Power-Supply Considerations

The ISL832X construction is typical of most CMOS analog switches, except that they have only two supply pins: V+ and GND. V+ and GND drive the internal CMOS switches and set their analog voltage limits. Unlike switches with a 13V maximum supply voltage, the ISL832X 15 V maximum supply voltage provides plenty of room for the $10 \%$ tolerance of 12 V supplies, as well as room for overshoot and noise spikes.
The minimum recommended supply voltage is 2.7 V . It is important to note that the input signal range, switching times, and on-resistance degrade at lower supply voltages. Refer to the electrical specification tables and Typical Performance curves for details.
V+ and GND also power the internal logic and level shifters. The level shifters convert the logic levels to switched V+ and GND signals to drive the analog switch gate terminals.
This family of switches cannot be operated with bipolar supplies, because the input switching point becomes negative in this configuration.

## Logic-Level Thresholds

This switch family is TTL compatible ( 0.8 V and 2.4 V ) over a supply range of 3 V to 11 V (see Figure 12). At 12 V the $\mathrm{V}_{\mathrm{IH}}$ level is about 2.5 V . This is still below the TTL guaranteed high output minimum level of 2.8 V , but noise margin is reduced. For best results with a 12 V supply, use a logic family the provides a $\mathrm{V}_{\mathrm{OH}}$ greater than 3 V .

The digital input stages draw supply current whenever the digital input voltage is not at one of the supply rails. Driving the digital input signals from GND to V+ with a fast transition time minimizes power dissipation.

## Leakage Considerations

Reverse ESD protection diodes are internally connected between each analog-signal pin and both V+ and GND. One of these diodes conducts if any analog signal exceeds V+ or GND.
Virtually all the analog leakage current comes from the ESD diodes to $\mathrm{V}+$ or GND. Although the ESD diodes on a given signal pin are identical and therefore fairly well balanced, they are reverse biased differently. Each is biased by either V+or GND and the analog signal. This means their leakages will vary as the signal varies. The difference in the two diode leakages to the V+ and GND pins constitutes the analog-signal-path leakage current. All analog leakage current flows between each pin and one of the supply terminals, not to the other switch terminal. This is why both sides of a given switch can show leakage currents of the same or opposite polarity. There is no connection between the analog-signal paths and $\mathrm{V}+$ or GND.

Typical Performance Curves $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, Unless Otherwise Specified


FIGURE 9. ON RESISTANCE vs SWITCH VOLTAGE


FIGURE 11. CHARGE INJECTION vs SWITCH VOLTAGE


FIGURE 13. TURN - ON TIME vs SUPPLY VOLTAGE


FIGURE 10. Ron MATCH vs SWITCH VOLTAGE


FIGURE 12. DIGITAL SWITCHING POINT vs SUPPLY VOLTAGE


FIGURE 14. TURN - OFF TIME vs SUPPLY VOLTAGE

## Die Characteristics

DIE DIMENSIONS:
ISL832X:
54 mils $\times 28$ mils ( $1370 \mu \mathrm{~m} \times 710 \mu \mathrm{~m}$ )
METALLIZATION:
Type: Metal 1: AISi(1\%)
Thickness: Metal 1: 8kA
Type: Metal 2: AISi (1\%)
Thickness: Metal 2: 10kA
SUBSTRATE POTENTIAL (POWERED UP): GND

## PASSIVATION:

Type: Silox
Thickness: 13kÅ
TRANSISTOR COUNT:
ISL8323: 66
ISL8324: 66
ISL8325: 66
PROCESS:
Si Gate CMOS

## Revision History

The revision history provided is for informational purposes only and is believed to be accurate, but not warranted. Please go to the web to make sure that you have the latest revision.

| DATE | REVISION | CHANGE |
| :---: | :---: | :---: |
| October 7, 2015 | FN6023.1 | Updated the Ordering Information table on page page 2. <br> Added Revision History and About Intersil sections. <br> Updated Package Outline Drawing M8.15 to the latest revision. Changes are as follows: <br> -New Revision. Remove "u" symbol from drawing (overlaps the "a" on Side View). <br> -Updated to new POD format by removing table and moving dimensions onto drawing and adding land pattern. <br> -Changed in Typical Recommended Land Pattern the following: $\begin{array}{\|l} 2.41(0.095) \text { to } 2.20(0.087) \\ 0.76(0.030) \text { to } 0.60(0.023) \\ 0.200 \text { to } 5.20(0.205) \end{array}$ <br> -Changed Note 1 "1982" to "1994". |

## About Intersil

Intersil Corporation is a leading provider of innovative power management and precision analog solutions. The company's products address some of the largest markets within the industrial and infrastructure, mobile computing and high-end consumer markets.

For the most updated datasheet, application notes, related documentation and related parts, please see the respective product information page found at www.intersil.com.

You may report errors or suggestions for improving this datasheet by visiting www.intersil.com/ask.
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For information regarding Intersil Corporation and its products, see www.intersil.com

## Package Outline Drawing

## M8.15

8 LEAD NARROW BODY SMALL OUTLINE PLASTIC PACKAGE
Rev 4, 1/12


## NOTES:

1. Dimensioning and tolerancing per ANSI Y14.5M-1994.
2. Package length does not include mold flash, protrusions or gate burrs Mold flash, protrusion and gate burrs shall not exceed 0.15 mm ( 0.006 inch) per side.
3. Package width does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.25 mm ( 0.010 inch ) per side.
4. The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
5. Terminal numbers are shown for reference only.
6. The lead width as measured 0.36 mm ( 0.014 inch ) or greater above the seating plane, shall not exceed a maximum value of 0.61 mm ( 0.024 inch ).
7. Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact.
8. This outline conforms to JEDEC publication MS-012-AA ISSUE C.

## X-ON Electronics

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